

Part Number: XZMG60W

3.0mmx1.5mm SMD CHIP LED LAMP

#### **Features**

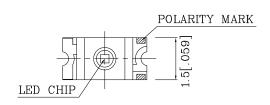
- 3.0mmx1.5mm SMT LED,1.4mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- $\bullet$  PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

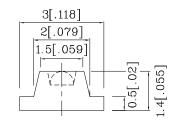




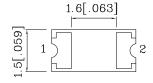
### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.20(0.008") unless otherwise noted.
- 3. Specifications are subject to change without notice.









Absolute Maximum Rati (TA=25°C)	MG (GaP)	Unit	
Reverse Voltage	VR	5	V
Forward Current	IF	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	iFS	140	mA
Power Dissipation	Рт	62.5	mW
Operating Temperature	TA	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

Operating Characteristic (TA=25°C)	MG (GaP)	Unit	
Forward Voltage (Typ.) (IF=20mA)	VF	2.2	V
Forward Voltage (Max.) (IF=20mA)	VF	2.5	V
Reverse Current (Max.) (VR=5V)	IR	10	uA
Wavelength Of Peak Emission (Typ.) (IF=20mA)	λΡ	565	nm
Wavelength Of Dominant Emission (Typ.) (IF=20mA)	λ D	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (IF=20mA)	Δλ	30	nm
Capacitance (Typ.) (VF=0V, f=1MHz)	C	15	pF

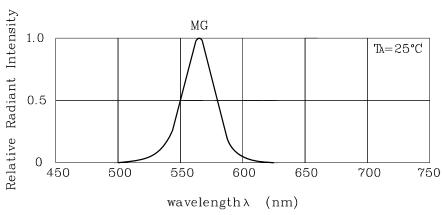
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=20mA) mcd		Wavelength nm λ P	Viewing Angle 2 0 1/2
				min.	typ.		
XZMG60W	Green	GaP	Water Clear	4	19	565	70°

Published Date : JAN 17, 2008 Drawing No : XDSA1406 V6 Checked : B.L.LIU P.1/4



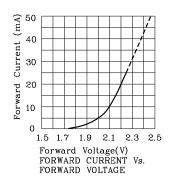


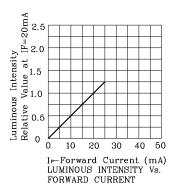
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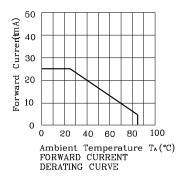


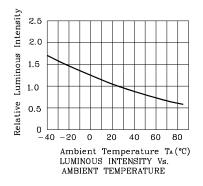
RELATIVE INTENSITY Vs. WAVELENGTH

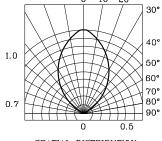
### **❖** MG











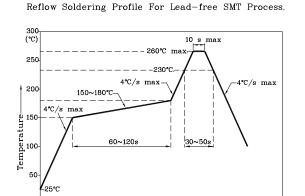
SPATIAL DISTRIBUTION



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NOTES:

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1. Maximum soldering temperature should not exceed 260°c.

200

250

300 (sec)

2. Recommended reflow temperature: 145°c-260°c.

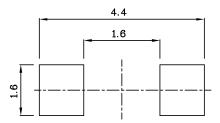
Time

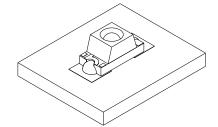
100

3. Do not put stress to the epoxy resin during high temperatures conditions.

150

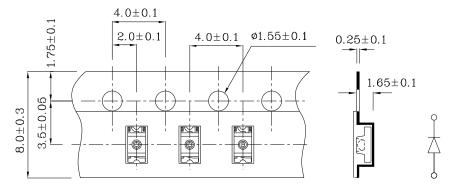
- **❖** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)
- ❖ The device has a single mounting surface. The device must be mounted according to the specifications.





❖ Tape Specification (Units:mm)





#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

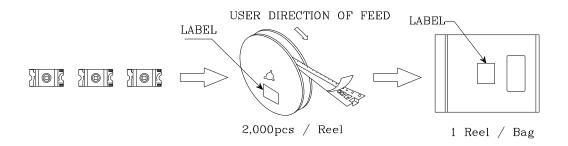


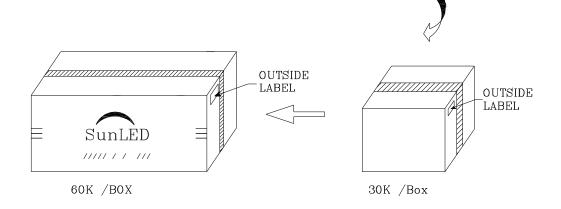
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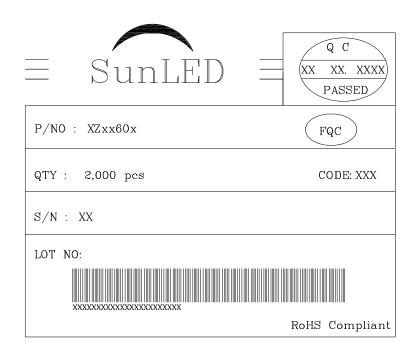
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# PACKING & LABEL SPECIFICATIONS

## XZMG60W







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